

# **FMV11N60E**

#### **FUJI POWER MOSFET**

## Super FAP-E<sup>3</sup> series

### **N-CHANNEL SILICON POWER MOSFET**

#### Features

Maintains both low power loss and low noise Lower R<sub>DS</sub>(on) characteristic More controllable switching dv/dt by gate resistance Smaller V<sub>GS</sub> ringing waveform during switching

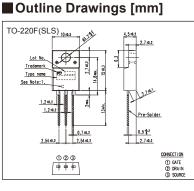
Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

#### Applications

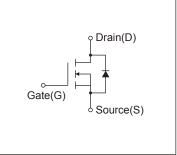
Switching regulators UPS (Uninterruptible Power Supply) **DC-DC** converters

#### Maximum Ratings and Characteristics

#### Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)



Equivalent circuit schematic



| Description  | Symbol | Characteristics | Unit  | Remarks                |  |
|--|--------|-----------------|-------|------------------------|--|
|  | VDS    | 600             | V     |                        |  |
| Drain-Source Voltage                                   | VDSX   | 600             | V     | V <sub>GS</sub> = -30V |  |
| Continuous Drain Current                               | lo     | ±11             | A     |                        |  |
| Pulsed Drain Current                                   | Idp    | ±44             | A     |                        |  |
| Gate-Source Voltage                                    | Vgs    | ±30             | V     |                        |  |
| Repetitive and Non-Repetitive Maximum AvalancheCurrent | lar    | 11              | А     | Note*1                 |  |
| Non-Repetitive Maximum Avalanche Energy                | Eas    | 384             | mJ    | Note*2                 |  |
| Repetitive Maximum Avalanche Energy                    | Ear    | 6.5             | mJ    | Note*3                 |  |
| Peak Diode Recovery dV/dt                              | dV/dt  | 4.9             | kV/µs | Note*4                 |  |
| Peak Diode Recovery -di/dt                             | -di/dt | 100             | A/µs  | Note*5                 |  |
| Maulaum Damas Disaination                              | PD     | 2.16            | W     | Ta=25°C                |  |
| Maximum Power Dissipation                              |        | 65              | vv    | Tc=25°C                |  |
| Operating and Starage Temperature range                | Tch    | 150             | °C    |                        |  |
| Operating and Storage Temperature range                | Tstg   | -55 to + 150    | °C    |                        |  |

#### • Electrical Characteristics at Tc=25°C (unless otherwise specified)

| Description                      | Symbol               | Conditions   |           | min. | typ.  | max. | Unit |
|----------------------------------|----------------------|--|-----------|------|-------|------|------|
| Drain-Source Breakdown Voltage   | BVDSS                | ID=250µA, VGS=0V   |           | 600  | -     | -    | V    |
| Gate Threshold Voltage           | V <sub>GS</sub> (th) | ID=250µA, VDS=VGS  |           | 2.5  | 3.0   | 3.5  | V    |
| Zero Gate Voltage Drain Current  |                      | V <sub>DS</sub> =600V, V <sub>GS</sub> =0V   | Tch=25°C  | -    | -     | 25   | μA   |
|                                  | IDSS                 | V <sub>DS</sub> =480V, V <sub>GS</sub> =0V   | Tch=125°C | -    | -     | 250  |      |
| Gate-Source Leakage Current      | Igss                 | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V   |           | -    | 10    | 100  | nA   |
| Drain-Source On-State Resistance | RDS (on)             | ID=5.5A, VGS=10V   |           | -    | 0.641 | 0.75 | Ω    |
| Forward Transconductance         | <b>g</b> fs          | ID=5.5A, VDS=25V   |           | 6    | 12    | -    | S    |
| Input Capacitance                | Ciss                 | V <sub>DS</sub> =25V<br>V <sub>GS</sub> =0V<br>f=1MHz  |           | -    | 1700  | 2550 | pF   |
| Output Capacitance               | Coss                 |  |           | -    | 150   | 225  |      |
| Reverse Transfer Capacitance     | Crss                 |  |           | -    | 11    | 16.5 |      |
| Turn-On Time                     | td(on)               | V <sub>cc</sub> =300V<br>V <sub>GS</sub> =10V<br>I <sub>D</sub> =5.5A<br>R <sub>G</sub> =15Ω |           | -    | 21    | 31.5 | ns   |
|                                  | tr                   |  |           | -    | 9.5   | 14.5 |      |
| Turn-Off Time                    | td(off)              |  |           | -    | 100   | 150  |      |
|                                  | tf                   |  |           | -    | 19    | 28.5 |      |
| Total Gate Charge                | QG                   | Vcc=300V<br>I₀=11A<br>Vcs=10V  |           | -    | 48.5  | 73   | nC   |
| Gate-Source Charge               | QGS                  |  |           | -    | 12.5  | 19   |      |
| Gate-Drain Charge                | QGD                  |  |           | -    | 14    | 21   |      |
| Avalanche Capability             | lav                  | L=2.64mH, Tch=25°C   |           | 11   | -     | -    | A    |
| Diode Forward On-Voltage         | Vsd                  | IF=11A, VGS=0V, Tch=25°C   |           | -    | 0.86  | 1.30 | V    |
| Reverse Recovery Time            | trr                  | I⊧=11A, V₀s=0V<br>-di/dt=100A/µs, Tch=25°C   |           | -    | 0.52  | -    | μS   |
| Reverse Recovery Charge          | Qrr                  |  |           | -    | 5.5   | -    | μC   |

#### Thermal Characteristics

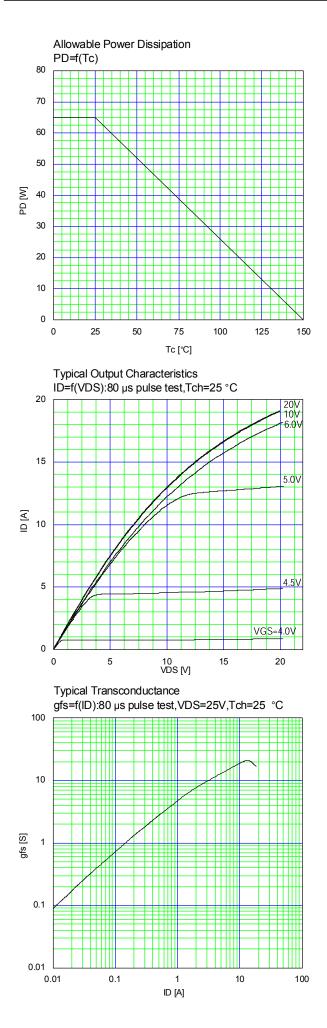
| Description        | Symbol     | Test Conditions    | min. | typ. | max.  | Unit |
|--------------------|------------|--------------------|------|------|-------|------|
| Thermal resistance | Rth (ch-c) | Channel to Case    |      |      | 1.920 | °C/W |
|                    | Rth (ch-a) | Channel to Ambient |      |      | 58.0  | °C/W |

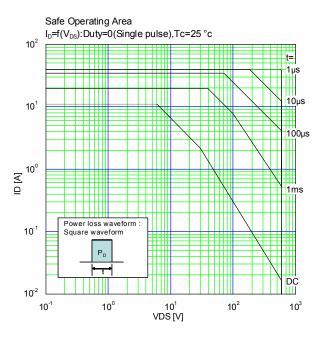
Note \*1 : Tch≤150°C

Note 1 : Italia 50 C, IAs=5A, L=28.2mH, Vcc=60V, R<sub>G</sub>=50Ω EAs limited by maximum channel temperature and avalanche current. See to 'Avalanche Energy' graph.

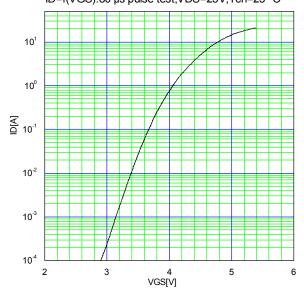
Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature.

See to the 'Transient Themal impeadance' graph. Note \*4 : IF≤-ID, -di/dt=100A/µs, Vcc≤BVoss, Tch≤150°C. Note \*5 : IF≤-ID, dv/dt=4.4kV/µs, Vcc≤BVoss, Tch≤150°C.

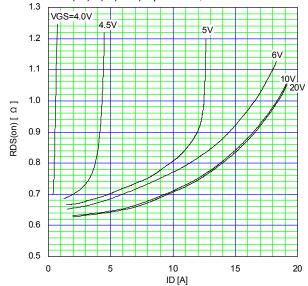


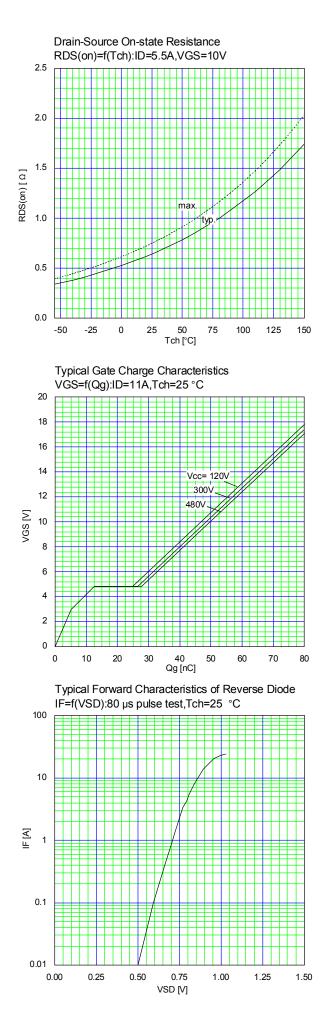


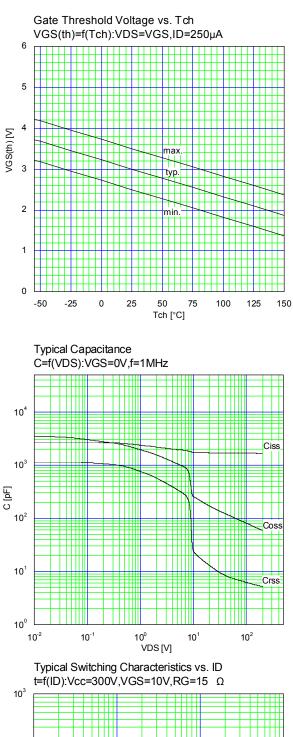
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25 °C

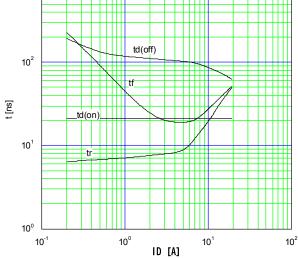


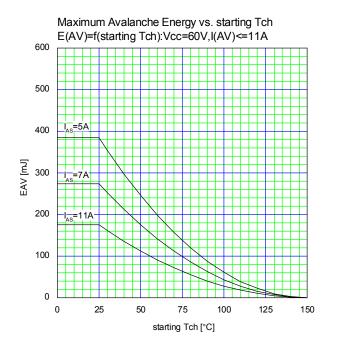
Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test,Tch=25 °C

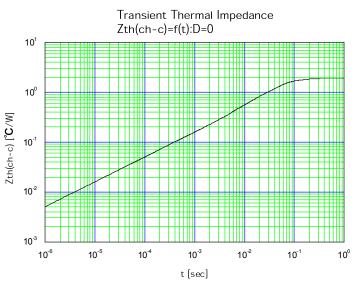












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